SiA440DJ Vishay Siliconix



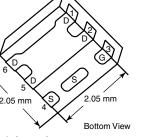
N-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω) (Max.)	I _D (A) ^a	Q _g (Typ.)	
40	0.026 at V _{GS} = 10 V	12		
	0.028 at V _{GS} = 4.5 V	12	6.9 nC	
	0.029 at V _{GS} = 3.7 V	12	0.9110	
	0.035 at V _{GS} = 2.5 V	12		

้ร 2.05 mm 2.05 mm **Bottom View**

Ordering Information:

PowerPAK SC-70-6L-Single

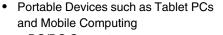


SiA440DJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

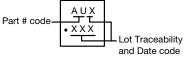
- TrenchFET[®] Power MOSFET
- 100 % R_{g} and UIS Tested
- Material categorization: For definitions of compliance please see www.vishav.com/doc?99912

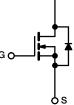
APPLICATIONS



- DC/DC Converter
- Boost Converter
- Load Switch
- Power Management
- LED Backlighting

Marking Code





RoHS

COMPLIANT

HALOGEN FREE

ОD

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	(T _A = 25 °C, unle	ess otherwise no	ted)		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	40	V	
Gate-Source Voltage		V _{GS}	± 12	7 ř	
	T _C = 25 °C		12 ^a		
Continuous Drain Current (T $= 150$ °C)	T _C = 70 °C		12 ^a		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C	I _D	8.6 ^{a,b, c}		
	T _A = 70 °C		6.9 ^{b, c}		
Pulsed Drain Current (t = 100 μs)		I _{DM}	50	A	
Continuous Courses Durits Diada Current	T _C = 25 °C	1	12 ^a		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.9 ^{b, c}		
ingle Avalanche Current		I _{AS}	11		
Single Avalanche Energy	L = 0.1 mH	E _{AS}	6	mJ	
Maximum Power Dissipation	T _C = 25 °C		19		
	T _C = 70 °C		12		
	T _A = 25 °C	P _D	3.5 ^{b, c}		
	T _A = 70 °C		2.2 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) ^{d, e}			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	28	36	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	5.3	6.5		

Notes:

a. Based on package limited.

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b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 80 °C/W.

For technical questions, contact:: pmostechsupport@vishay.com

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	· · · · ·						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	40			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			39		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 3.6			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	0.6		1.4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ	
		V_{DS} = 40 V, V_{GS} = 0 V, T_{J} = 55 °C			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	10			Α	
	_ (*:.)	V _{GS} = 10 V, I _D = 9 A		0.021	0.026	- Ω	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 7 \text{ A}$		0.022	0.028		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 3.7 \text{ V}, I_D = 7 \text{ A}$		0.023	0.029		
	-	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 7 \text{ A}$		0.026	0.035		
Forward Transconductance ^a	g _{fs}	V _{DS} = 10 V, I _D = 9 A		45		S	
Dynamic ^b		-		1	L		
Input Capacitance	C _{iss}		1	700		pF	
Output Capacitance	C _{oss}	V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz		87			
Reverse Transfer Capacitance	C _{rss}	20 00		40			
·		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 9 \text{ A}$		14.3	21.5	nC	
Total Gate Charge	Qg			6.9	10.5		
Gate-Source Charge	Q _{gs}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 9 \text{ A}$		1.4			
Gate-Drain Charge	Q _{gd}			2			
Gate Resistance	R _g	f = 1 MHz	0.2	1	2	Ω	
Turn-On Delay Time	t _{d(on)}			7	15		
Rise Time	t _r	V_{DD} = 20 V, R_L = 2.9 Ω		5	10	-	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong \text{7}$ A, V_GEN = 10 V, R_g = 1 Ω		20	40		
Fall Time	t _f			3	10		
Turn-On Delay Time	t _{d(on)}			12	25	ns	
Rise Time	t _r	V_{DD} = 20 V, R_L = 2.9 Ω		32	65	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 7 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		23	45		
Fall Time	t _f	Ŭ		5	10	1	
Drain-Source Body Diode Characteristic					1	1	
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			12	_	
Pulse Diode Forward Current (t = 100 μ s)	I _{SM}			1	50	A	
Body Diode Voltage	V _{SD}	I _S = 7 A		0.85	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			15	30	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			7.5	15	nC	
Reverse Recovery Fall Time	t _a	I _F = 7 A, dl/dt = 100 A/μs, T _J = 25 °C		9		ns	
Reverse Recovery Rise Time	t _b			6			

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

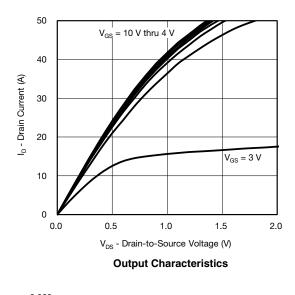
b. Guaranteed by design, not subject to production testing.

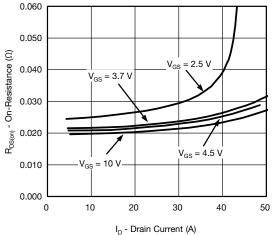
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



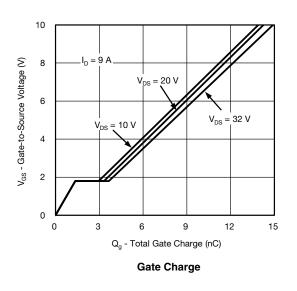
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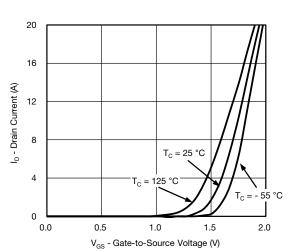
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



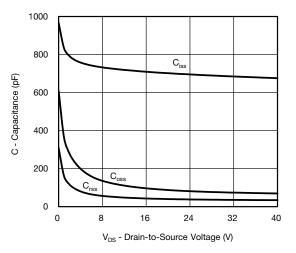


On-Resistance vs. Drain Current and Gate Voltage

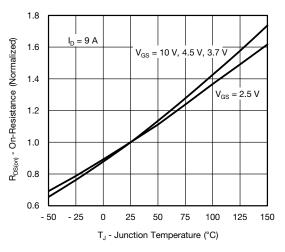




Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

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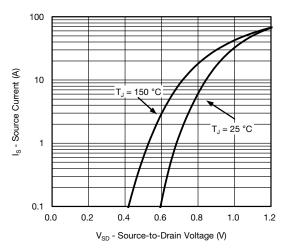
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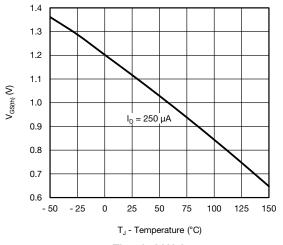
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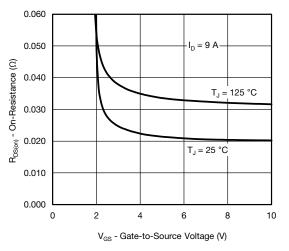
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



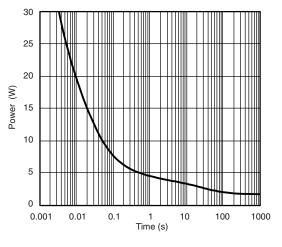
Source-Drain Diode Forward Voltage



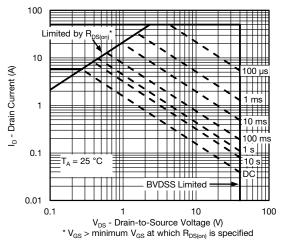
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

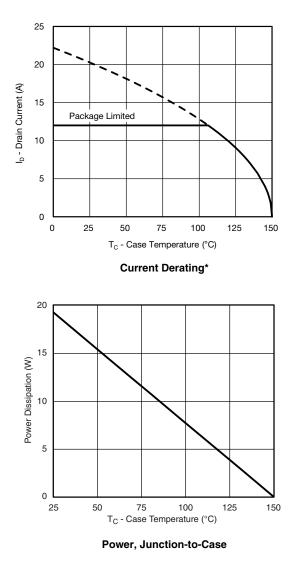


Safe Operating Area, Junction-to-Ambient

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



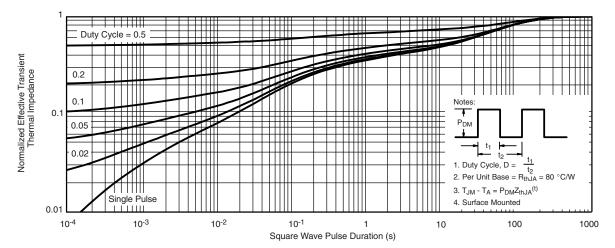
* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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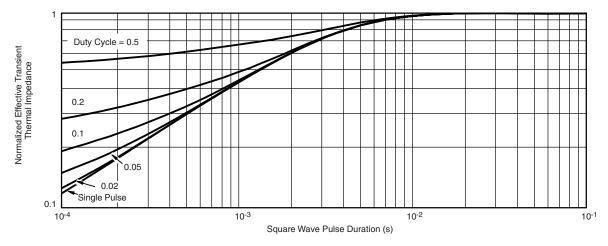


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg264138.

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PowerPAK[®] SC70-6L

VISHA

b PIN2 PIN1 PIN3 _ ₹



b

PIN3

__ ₿

PIN2

PIN1

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RECOMMENDED PAD LAYOUT FOR PowerPAK[®] SC70-6L Single



Dimensions in mm/(Inches)

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